



CER Series Controlled ESR Capacitors

Type:

CERB (C1608) CERD (C2012)

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Downloaded from Elcodis.com electronic components distributor

REMINDERS

Please read before using this product

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MULTILAYER CERAMIC CHIP CAPACITORS

PC server

· Voltage regulator

· Plane termination

USB damping circuit

· Output filters



CER Series

Controlled ESR Capacitors

Type: CERB (C1608), CERD (C2012)

Features



• This is a ceramic chip capacitor with the additional function of controlling (assures design of) the ESR (Equivalent Series Resistance) value as desired.

• This function enables control of voltage change, which can occur between the power source and the CPU, by controlling the impedance of capacitors located around the CPU.

• This enables a reduction in the number of parts used and contributes to cost savings, set downsizing, and upgrading quality.

• The replacement of existing products is easy because the mounting method is the same as products with two terminals.

PC Board Pattern



Applications



Shape & Dimensions





· Power decoupling and smoothing

Tantalum capacitor replacement



Dimensions in mm

OVE



Part Number Construction

<u>CERD 2J X5R 0G 106 M T XXXX</u>



• All specifications are subject to change without notice. Please read the precautions before using the product

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MULTILAYER CERAMIC CHIP CAPACITORS



Capacitance Range Table

CERB [EIA CC0603]

Class 2 (Temperature Stable)

Temperature Characteristics: X5R (± 15%)

TDK Part Number (Ordering Code)	ESR	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CERB2CX5R0G105M	200 m Ω ± 30%	X5R	4V	1,000,000	± 20%	0.80 ± 0.10
CERB2MX5R0G105M	650 m Ω ± 30%	X5R	4V	1,000,000	± 20%	0.80 ± 0.10
CERB3UX5R0G105M	1,200 mΩ ± 30%	X5R	4V	1,000,000	± 20%	0.80 ± 0.10



Capacitance Range Table

CERD [EIA CC0805]

Class 2 (Temperature Stable)

Temperature Characteristics: X5R (± 15%)

TDK Part Number (Ordering Code)	ESR	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
CERD1CX5R0G106M	20 mΩ ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15
CERD1FX5R0G106M	35 m Ω ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15
CERD1JX5R0G106M	50 m Ω ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15
CERD2AX5R0G106M	100 m Ω ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15
CERD2CX5R0G106M	200 mΩ ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15
CERD2JX5R0G106M	500 mΩ ± 30%	X5R	4V	10,000,000	± 20%	0.85 ± 0.15

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